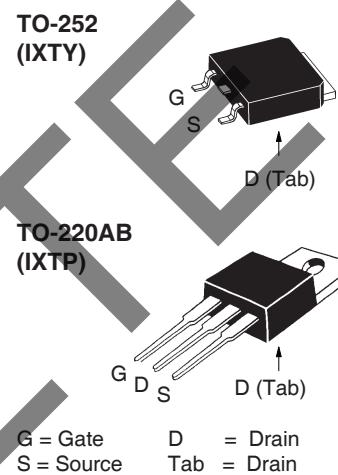
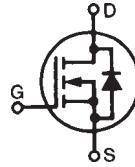


**Polar™**  
**Power MOSFET**

**IXTY1R6N50P**  
**IXTP1R6N50P**

**V<sub>DSS</sub>** = 500V  
**I<sub>D25</sub>** = 1.6A  
**R<sub>DS(on)</sub>** ≤ 6.5Ω

N-Channel Enhancement Mode  
Avalanche Rated  
Fast Intrinsic Rectifier



Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	500	V	
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 150°C, R <sub>GS</sub> = 1MΩ	500	V	
V <sub>GSS</sub>	Continuous	±30	V	
V <sub>GSM</sub>	Transient	±40	V	
I <sub>D25</sub>	T <sub>C</sub> = 25°C	1.6	A	
I <sub>DM</sub>	T <sub>C</sub> = 25°C, Pulse Width Limited by T <sub>JM</sub>	2.5	A	
I <sub>A</sub>	T <sub>C</sub> = 25°C	1.6	A	
E <sub>AS</sub>	T <sub>C</sub> = 25°C	75	mJ	
dv/dt	I <sub>S</sub> ≤ I <sub>DM</sub> , V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C	10	V/ns	
P <sub>D</sub>	T <sub>C</sub> = 25°C	43	W	
T <sub>J</sub>		-55 ... +150	°C	
T <sub>JM</sub>		150	°C	
T <sub>stg</sub>		-55 ... +150	°C	
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300	°C	
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260	°C	
F <sub>c</sub>	Mounting Force (TO-263)	10.65 / 2.2..14.6	N/lb	
M <sub>d</sub>	Mounting Torque (TO-220)	1.13 / 10	Nm/lb.in	
Weight	TO-252	0.35	g	
	TO-220	3.00	g	

Symbol	Test Conditions (T <sub>J</sub> = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	500		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 25μA	3.0		V
I <sub>GSS</sub>	V <sub>GS</sub> = ± 20V, V <sub>DS</sub> = 0V		±50	nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V		1	μA
	T <sub>J</sub> = 125°C		50	μA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5 • I <sub>D25</sub> , Notes 1, 2		6.5	Ω

#### Features

- International Standard Packages
- Low Q<sub>G</sub>
- Avalanche Rated
- Low Package Inductance
- Fast Intrinsic Rectifier

#### Advantages

- High Power Density
- Easy to Mount
- Space Savings

#### Applications

- DC-DC Converters
- Switch-Mode and Resonant-Mode Power Supplies
- AC and DC Motor Drives
- Discharge Circuits in Lasers, Spark Igniters, RF Generators
- High Voltage Pulse Power Applications

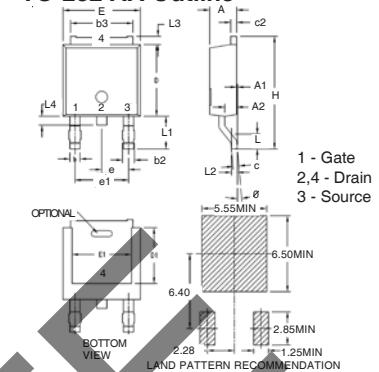
Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 20\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1	0.7	1.3	S
$C_{iss}$		140		pF
$C_{oss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 25\text{V}$ , $f = 1\text{MHz}$	20		pF
$C_{rss}$		2.6		pF
$t_{d(on)}$		20		ns
$t_r$		26		ns
$t_{d(off)}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	45		ns
$t_f$	$R_G = 50\Omega$ (External)	23		ns
$Q_{g(on)}$		3.9		nc
$Q_{gs}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	1.4		nc
$Q_{gd}$		1.3		nc
$R_{thJC}$			2.9	$^\circ\text{C}/\text{W}$
$R_{thCS}$	TO-220	0.50		$^\circ\text{C}/\text{W}$

### Source-Drain Diode

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$I_s$	$V_{GS} = 0\text{V}$		1.6	A
$I_{SM}$	Repetitive, Pulse Width Limited by $T_{JM}$		5.0	A
$V_{SD}$	$I_F = I_S$ , $V_{GS} = 0\text{V}$ , Note 1		1.5	V
$t_{rr}$	$I_F = 1.6\text{A}$ , $V_{GS} = 0\text{V}$ , $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 100\text{V}$	400		ns

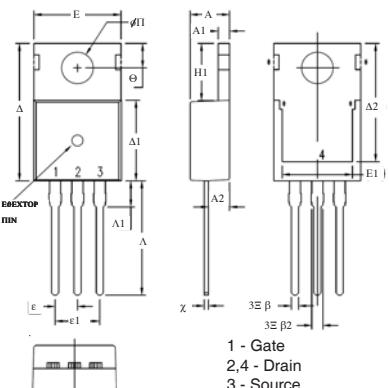
Notes: 1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .  
 2. On through-hole package,  $R_{DS(on)}$  Kelvin test contact location must be 5mm or less from the package body.

### TO-252 AA Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.086	.094	2.19	2.38
A1	0	.005	0	0.12
A2	.038	.046	0.97	1.17
b	.025	.035	0.64	0.89
b2	.030	.045	0.76	1.14
b3	.200	.215	5.08	5.46
c	.018	.024	0.46	0.61
c2	.018	.023	0.46	0.58
D	.235	.245	5.97	6.22
D1	.180	.205	4.57	5.21
E	.250	.265	6.35	6.73
E1	.170	.205	4.32	5.21
e	.090 BSC		2.28 BSC	
e1	.180 BSC		4.57 BSC	
H	.370	.410	9.40	10.42
L	.055	.070	1.40	1.78
L1	.100	.115	2.54	2.92
L2	.020 BSC		0.50 BSC	
L3	.025	.040	0.64	1.02
L4	.025	.040	0.64	1.02
ØP	0*	10*	0*	10*

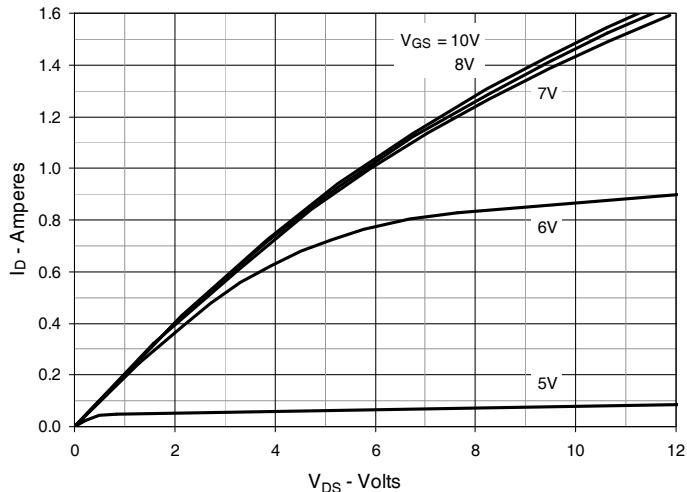
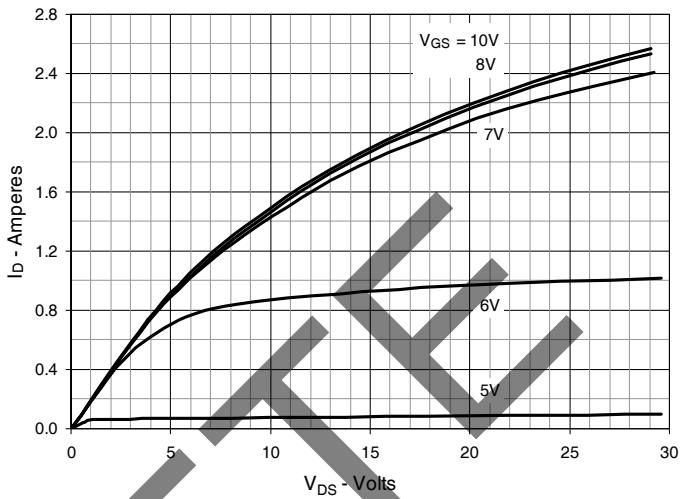
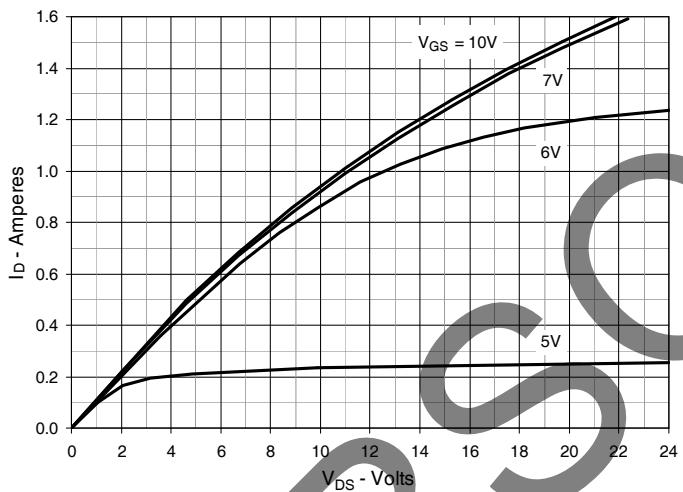
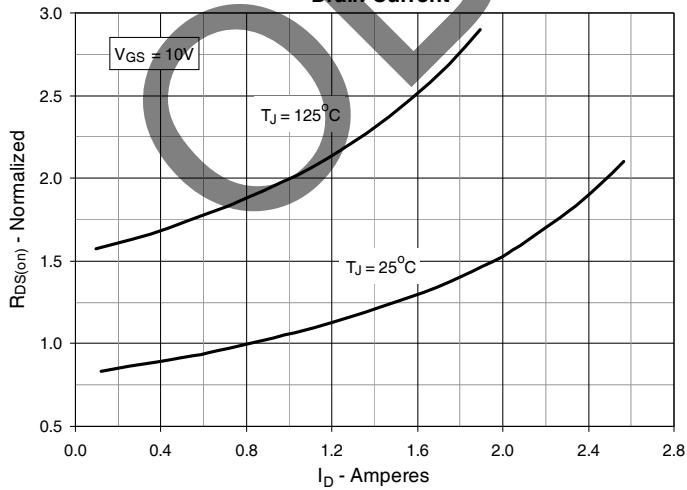
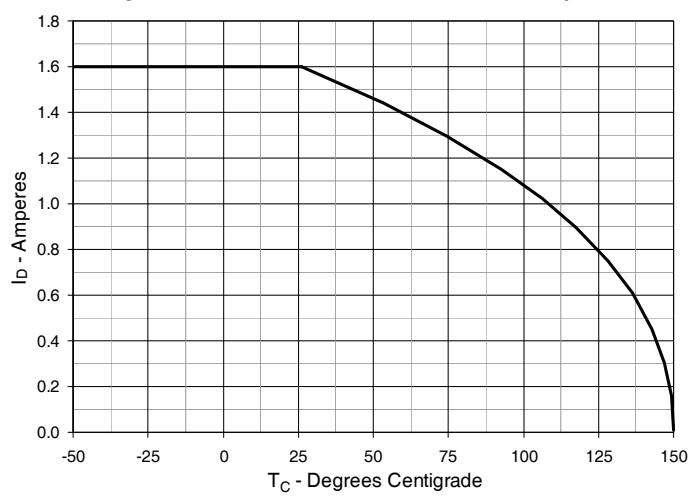
### TO-220 Outline



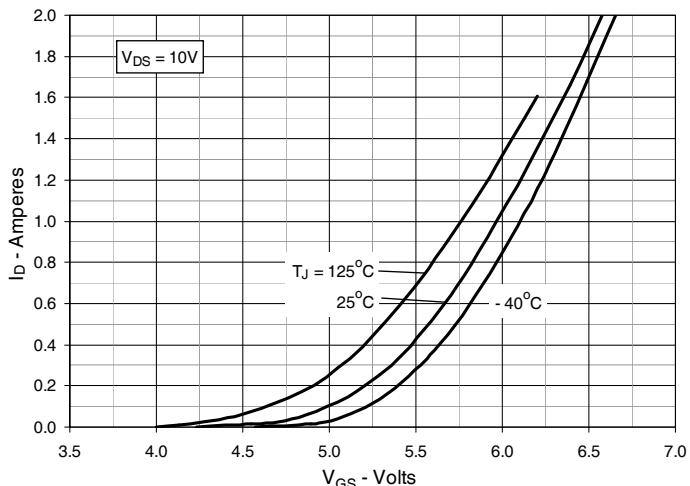
SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.169	.185	4.30	4.70
A1	.047	.055	1.20	1.40
A2	.079	.106	2.00	2.70
b	.024	.039	0.60	1.00
b2	.045	.057	1.15	1.45
c	.014	.026	0.35	0.65
D	.587	.626	14.90	15.90
D1	.335	.370	8.50	9.40
(D2)	.500	.531	12.70	13.50
E	.382	.406	9.70	10.30
(E1)	.283	.323	7.20	8.20
e	.100 BSC		2.54 BSC	
e1	.200 BSC		5.08 BSC	
H1	.244	.268	6.20	6.80
L	.492	.547	12.50	13.90
L1	.110	.154	2.80	3.90
ØP	.134	.150	3.40	3.80
Q	.106	.126	2.70	3.20

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

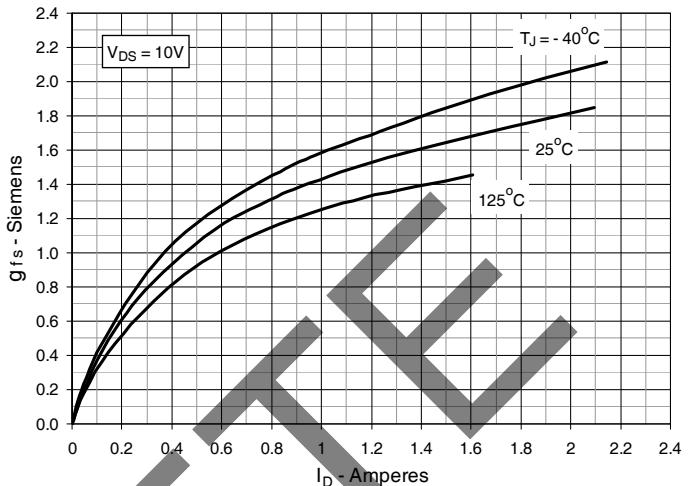
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592, 4,931,844, 5,049,961, 5,237,481, 6,162,665, 6,404,065 B1, 6,683,344, 6,727,585, 7,005,734 B2, 7,157,338B2, 4,860,072, 5,017,508, 5,063,307, 5,381,025, 6,259,123 B1, 6,534,343, 6,710,405 B2, 6,759,692, 7,063,975 B2, 4,881,106, 5,034,796, 5,187,117, 5,486,715, 6,306,728 B1, 6,583,505, 6,710,463, 6,771,478 B2, 7,071,537

**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$** 

**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 0.8A$  Value vs. Drain Current**

**Fig. 6. Maximum Drain Current vs. Case Temperature**


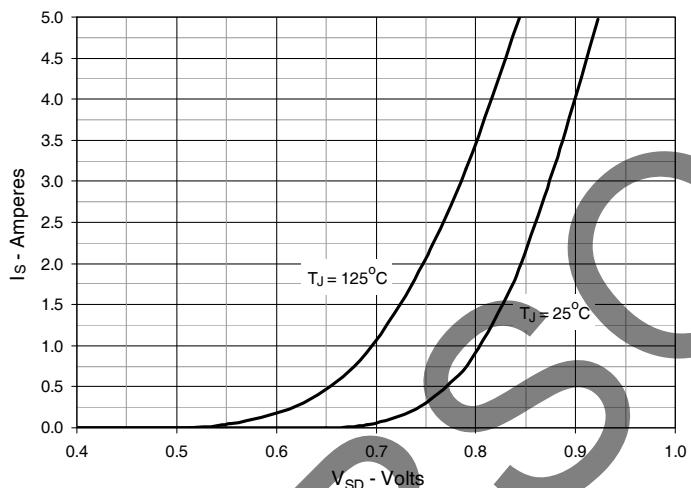
**Fig. 8. Input Admittance**



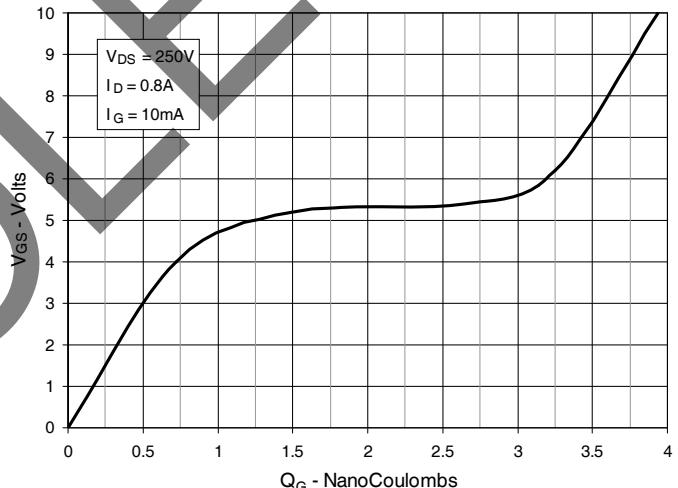
**Fig. 9. Transconductance**



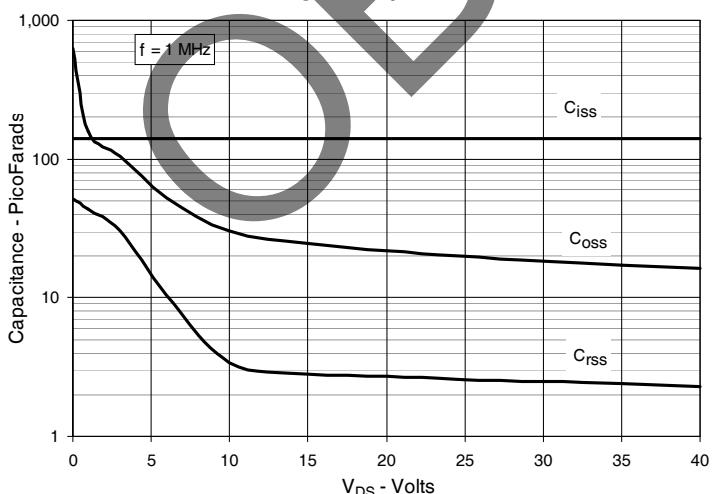
**Fig. 10. Forward Voltage Drop of Intrinsic Diode**



**Fig. 11. Gate Charge**



**Fig. 12. Capacitance**



**Fig. 14. Forward-Bias Safe Operating Area**

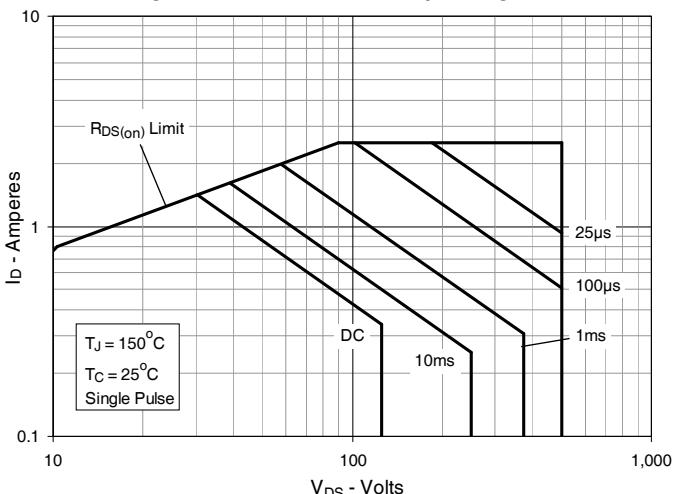


Fig. 13. Maximum Transient Thermal Impedance

